

## **General Description**

The WSF12N10 is the highest performance trench N-ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF12N10 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

## **Product Summery**

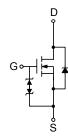
BVDSS	RDSON	ID
100V	175mΩ	12A

## **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch

## **TO-252 Pin Configuration**





## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	10	Α
I <sub>D</sub> @T <sub>C</sub> =100℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	7	Α
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	15	Α
EAS	Single Pulse Avalanche Energy <sup>3</sup>	15	mJ
I <sub>AS</sub>	Avalanche Current	6	Α
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation <sup>3</sup>	60	W
P <sub>D</sub> @T <sub>C</sub> =100℃	Total Power Dissipation <sup>3</sup>	30	W
T <sub>STG</sub>	Storage Temperature Range -55 to 170		°C
TJ	Operating Junction Temperature Range	-55 to 170	℃

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>0JA</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		50	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case <sup>1</sup>		2.5	°C/W



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	100			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25℃ , I <sub>D</sub> =1mA		0.098		V/°C
D	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =5A		175	220	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =2A		220	310	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	\/\/\	1.0	1.8	2.4	٧
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$-V_{GS}=V_{DS}$ , $I_D=250uA$		-4.57		mV/℃
	Drain Source Leakage Current	$V_{DS}$ =80V , $V_{GS}$ =0V , $T_J$ =25 $^{\circ}$ C			1	
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =80V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20 V$ , $V_{DS}$ = $0 V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =5A		13		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2	4	Ω
$Q_g$	Total Gate Charge (10V)	V <sub>DS</sub> =50V , V <sub>GS</sub> =10V , I <sub>D</sub> =5A	6.0	9.5	13	
$Q_gs$	Gate-Source Charge		1.3	1.9	2.5	nC
$Q_gd$	Gate-Drain Charge		1.0	2.1	3.1	
$T_{d(on)}$	Turn-On Delay Time			11	21	
T <sub>r</sub>	Rise Time	$V_{DD}$ =30V , $V_{GS}$ =10V , $R_{G}$ =6 $\Omega$		10	19	
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =1A , R <sub>L</sub> =30Ω		21	39	ns
T <sub>f</sub>	Fall Time			13	24	1
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =30V , V <sub>GS</sub> =0V , f=1MHz	310	440	570	
C <sub>oss</sub>	Output Capacitance		22	36	50	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		10	20	30	

#### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy <sup>5</sup>	V <sub>DD</sub> =25V , L=0.5mH , I <sub>AS</sub> =3A	10			mJ

### **Diode Characteristics**

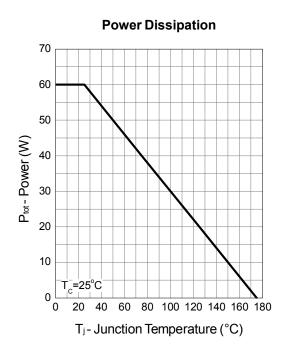
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>	V =V =0V Force Current			3	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	$V_G=V_D=0V$ , Force Current			9	Α
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =3A , T <sub>J</sub> =25℃			1.1	V
t <sub>rr</sub>	Reverse Recovery Time		25	36	47	nS
Q <sub>rr</sub>	Reverse Recovery Charge	IF=5A,dI/dt=100A/µs,T <sub>J</sub> =25℃	34	49	64	nC

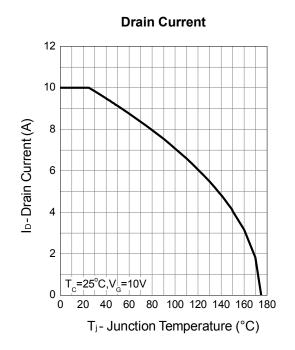
#### Note:

- 1. The data tested by surface mounted on a 1 inch  $^2$  FR-4 board with 2OZ copper,  $t \le 10 sec$ .
- 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3.The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, L\text{=}0.5\text{mH}, I_{\text{AS}}\text{=}3\text{A}$
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

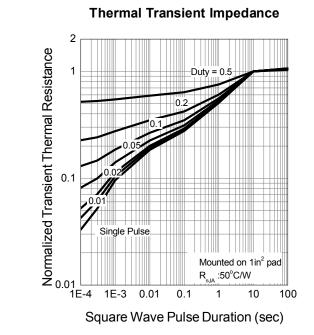


## **Typical Characteristics**





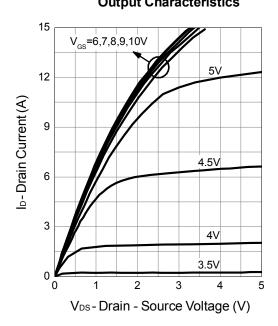
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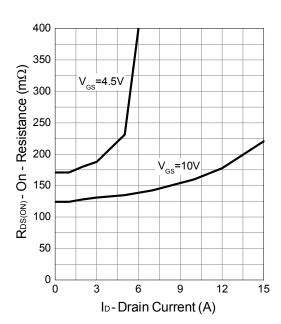


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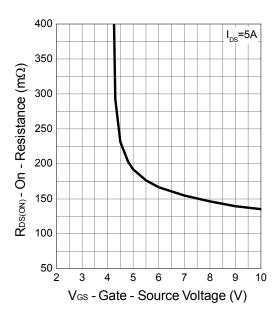
# Output Characteristics



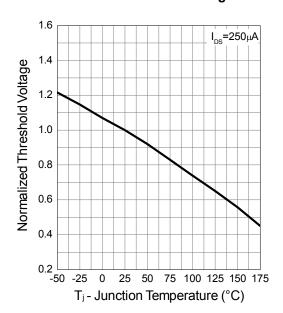
### **Drain-Source On Resistance**



#### **Gate-Source On Resistance**



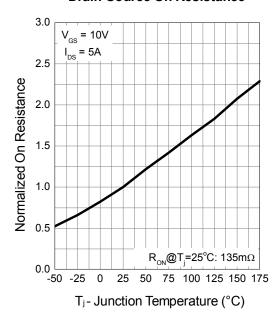
## **Gate Threshold Voltage**



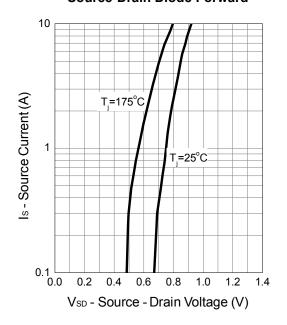


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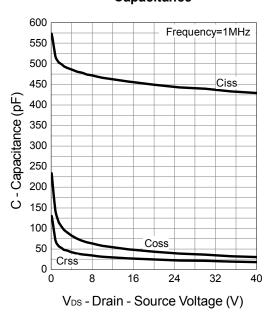
#### **Drain-Source On Resistance**



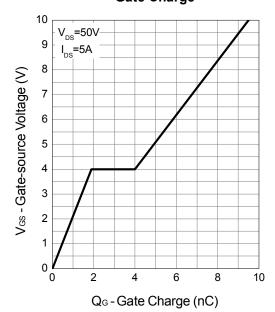
#### **Source-Drain Diode Forward**



## Capacitance



## **Gate Charge**





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